

# Silicon Carbide (SiC) MOSFET - 44 mohm, 650 V, M2, D2PAK-7L NTBG060N065SC1

	ITL	

- Typ.  $R_{DS(on)} = 44 \text{ m}\Omega$  @  $V_{GS} = 18 \text{ V}$ Typ.  $R_{DS(on)} = 60 \text{ m}\Omega$  @  $V_{GS} = 15 \text{ V}$
- Ultra Low Gate Charge (Q<sub>G(tot)</sub> = 74 nC)
- Low Output Capacitance (Coss = 133 pF)
- 100% Avalanche Tested
- $T_J = 175^{\circ}C$
- RoHS Compliant

## **Typical Applications**

- SMPS (Switching Mode Power Supplies)
- Solar Inverters
- UPS (Uninterruptable Power Supplies)
- Energy Storage

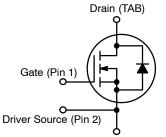
# **MAXIMUM RATINGS** ( $T_J = 25^{\circ}C$ unless otherwise noted)

Para	Symbol	Value	Unit		
Drain-to-Source Volta	$V_{DSS}$	650	V		
Gate-to-Source Voltage	ge		$V_{GS}$	-8/+22	V
Recommended Operatives of Gate – Source \		T <sub>C</sub> < 175°C	$V_{GSop}$	-5/+18	V
Continuous Drain Current (Note 2)	Steady State	T <sub>C</sub> = 25°C	I <sub>D</sub>	46	Α
Power Dissipation (Note 2)			P <sub>D</sub>	170	W
Continuous Drain Current (Notes 1, 2)	Steady State	T <sub>C</sub> = 100°C	I <sub>D</sub>	33	Α
Power Dissipation (Notes 1, 2)			P <sub>D</sub>	85	W
Pulsed Drain Current (Note 3) T <sub>C</sub> = 25°C			I <sub>DM</sub>	130	Α
Operating Junction and Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	ç		
Source Current (Body	I <sub>S</sub>	46	Α		
Single Pulse Drain-to- Energy (I <sub>L</sub> = 10.1 A <sub>pk</sub> ,	E <sub>AS</sub>	51	mJ		
Maximum Lead Tempe from Case for 10 Seco		oldering, 1/8"	TL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Surface mounted on a FR-4 board using1 in2 pad of 2 oz copper.
- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 3. Repetitive rating, limited by max junction temperature.
- 4.  $E_{AS}$  of 51 mJ is based on starting  $T_J$  = 25°C; L = 1 mH,  $I_{AS}$  = 10.1 A,  $V_{DD}$  = 50 V,  $V_{GS}$  = 18 V.

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
650 V	70 mΩ @ 18 V	46 A



Power Source (Pins 3, 4, 5, 6, 7)

#### **N-CHANNEL MOSFET**



D2PAK-7L CASE 418BJ

#### **MARKING DIAGRAM**

BG060N 065SC1 AYWWZZ

BG060N065SC1 = Specific Device Code

A = Assembly Location

Y = Year WW = Work Week ZZ = Lot Traceability

#### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
NTBG060N065SC1	D2PAK-7L	800 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

# THERMAL CHARACTERISTICS

Parameter	Symbol	Тур	Max	Units
Thermal Resistance Junction-to-Case (Note 2)	$R_{ heta JC}$	0.88	-	°C/W
Thermal Resistance Junction-to-Ambient (Notes 1, 2)	$R_{ heta JA}$	-	40	°C/W

#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = 25°C unless otherwise stated)

Parameter	Symbol	Test C	Condition	Min	Тур	Max	Unit
OFF CHARACTERISTICS					1		ı
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0	V, I <sub>D</sub> = 1 mA	650			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> /T <sub>J</sub>	I <sub>D</sub> = 20 mA	, refer to 25°C		0.15		V/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V	T <sub>J</sub> = 25°C			10	μΑ
		$V_{DS} = 650 \text{ V}$	T <sub>J</sub> = 175°C			1	mA
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = +18/-	-5 V, V <sub>DS</sub> = 0 V			250	nA
ON CHARACTERISTICS							•
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}$	; , I <sub>D</sub> = 6.5 mA	1.8	2.8	4.3	V
Recommended Gate Voltage	$V_{GOP}$			-5		+18	V
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 15 V, I <sub>D</sub>	= 20 A, T <sub>J</sub> = 25°C		60		mΩ
		V <sub>GS</sub> = 18 V, I <sub>D</sub>	= 20 A, T <sub>J</sub> = 25°C		44	70	
		V <sub>GS</sub> = 18 V, I <sub>D</sub> =	= 20 A, T <sub>J</sub> = 175°C		50		
Forward Transconductance	9 <sub>FS</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 20 A			12		S
CHARGES, CAPACITANCES & GATE RESI	STANCE						
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> = 0 V, f = 1 MHz, V <sub>DS</sub> = 325 V			1473		pF
Output Capacitance	C <sub>OSS</sub>	V <sub>DS</sub>	= 325 V		133		
Reverse Transfer Capacitance	C <sub>RSS</sub>				13		
Total Gate Charge	Q <sub>G(TOT)</sub>		V, V <sub>DS</sub> = 520 V,		74		nC
Gate-to-Source Charge	$Q_{GS}$	ID :	= 20 A		20		
Gate-to-Drain Charge	$Q_{GD}$				23		
Gate-Resistance	$R_{G}$	f = 1 MHz			3.9		Ω
SWITCHING CHARACTERISTICS							I
Turn-On Delay Time	t <sub>d(ON)</sub>	$V_{GS} = -5/18$	V, V <sub>DS</sub> = 400 V,		11		ns
Rise Time	t <sub>r</sub>	I <sub>D</sub> = 20 A. Induc	, R <sub>G</sub> = 2.2 Ω, tive Load		14		
Turn-Off Delay Time	t <sub>d(OFF)</sub>				24		
Fall Time	t <sub>f</sub>				11		
Turn-On Switching Loss	E <sub>ON</sub>				45		μJ
Turn-Off Switching Loss	E <sub>OFF</sub>				18		
Total Switching Loss	E <sub>TOT</sub>				63		
SOURCE-DRAIN DIODE CHARACTERISTI	cs						
Continuous Source-Drain Diode Forward Current	I <sub>SD</sub>	V <sub>GS</sub> = -5	V, T <sub>J</sub> = 25°C			46	Α
Pulsed Source-Drain Diode Forward Current (Note 3)	I <sub>SDM</sub>	V <sub>GS</sub> = -5 V, T <sub>J</sub> = 25°C				130	Α
Forward Diode Voltage	V <sub>SD</sub>	$V_{GS} = -5 \text{ V}, I_{SD}$	<sub>0</sub> = 20 A, T <sub>J</sub> = 25°C		4.3		V

# **ELECTRICAL CHARACTERISTICS** ( $T_J = 25^{\circ}C$ unless otherwise stated)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
SOURCE-DRAIN DIODE CHARACTER	RISTICS		•			
Reverse Recovery Time	t <sub>RR</sub>	$V_{GS} = -5/18 \text{ V}, I_{SD} = 20 \text{ A},$		17.7		ns
Reverse Recovery Charge	Q <sub>RR</sub>	dl <sub>S</sub> /dt = 1000 A/μs		90.6		nC
Reverse Recovery Energy	E <sub>REC</sub>			8.7		μJ
Peak Reverse Recovery Current	I <sub>RRM</sub>			10.2		Α
Charge time	Ta			9.8		ns
Discharge time	Tb			7.8		ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### **TYPICAL CHARACTERISTICS**

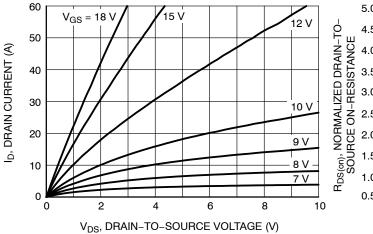


Figure 1. On-Region Characteristics

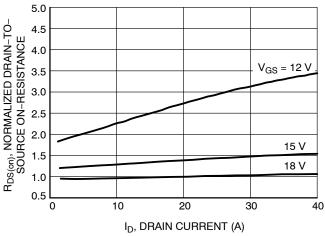


Figure 2. Normalized On-Resistance vs. Drain Current and Gate Voltage

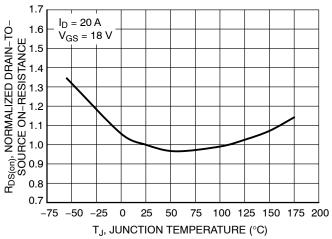


Figure 3. On–Resistance Variation with Temperature

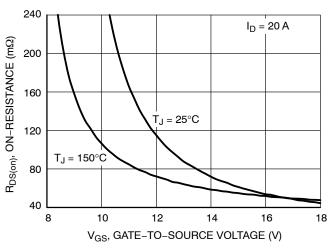


Figure 4. On-Resistance vs. Gate-to-Source Voltage

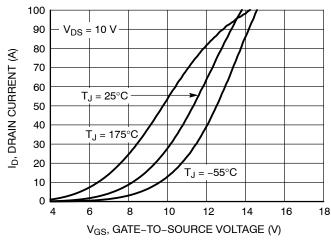


Figure 5. Transfer Characteristics

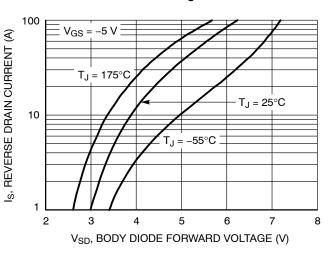


Figure 6. Diode Forward Voltage vs. Current

#### **TYPICAL CHARACTERISTICS**

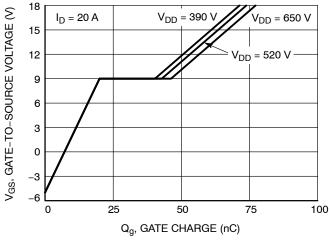


Figure 7. Gate-to-Source Voltage vs. Total Charge

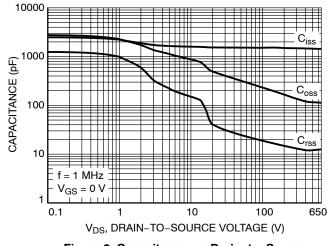


Figure 8. Capacitance vs. Drain-to-Source Voltage

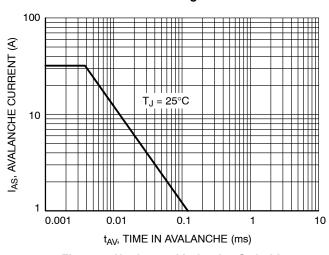


Figure 9. Unclamped Inductive Switching Capability

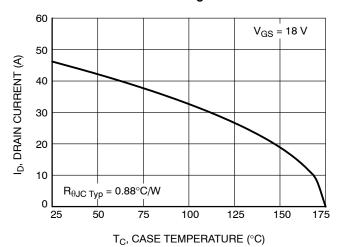


Figure 10. Maximum Continuous Drain Current vs. Case Temperature

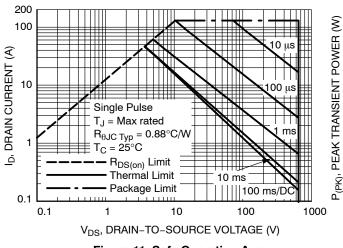


Figure 11. Safe Operating Area

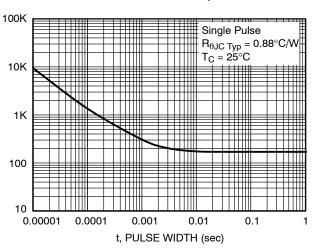


Figure 12. Single Pulse Maximum Power Dissipation

# **TYPICAL CHARACTERISTICS**

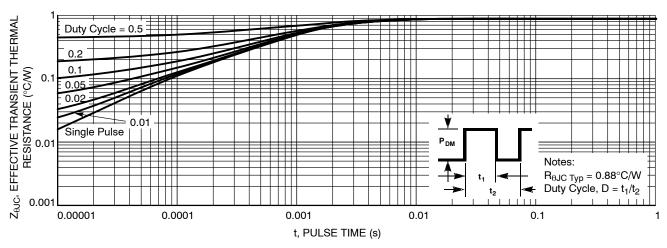


Figure 13. Junction-to-Case Transient Thermal Response

1

#### D<sup>2</sup>PAK7 (TO-263-7L HV) CASE 418BJ **ISSUE B**

**DATE 16 AUG 2019** 

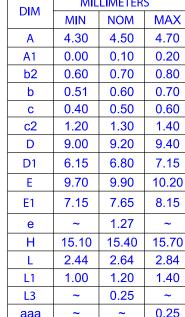
#### NOTES:

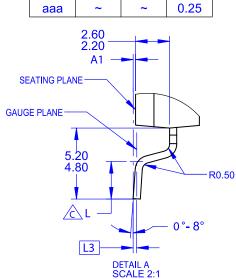
- A. PACKAGE CONFORMS TO JEDEC TO-263 VARIATION CB EXCEPT WHERE NOTED. B. ALL DIMENSIONS ARE IN MILLIMETERS.
- OUT OF JEDEC STANDARD VALUE.

  D. DIMENSION AND TOLERANCE AS PER ASME Y14.5-2009.

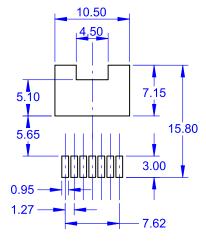
  E. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.

DIM	MILLIMETERS				
DIM	MIN	NOM	MAX		
Α	4.30	4.50	4.70		
A1	0.00	0.10	0.20		
b2	0.60	0.70	0.80		
b	0.51	0.60	0.70		
С	0.40	0.50	0.60		
c2	1.20	1.30	1.40		
D	9.00	9.20	9.40		
D1	6.15	6.80	7.15		
Е	9.70	9.90	10.20		
E1	7.15	7.65	8.15		
е	~	1.27	~		
Н	15.10	15.40	15.70		
L	2.44	2.64	2.84		
L1	1.00	1.20	1.40		
L3	~	0.25	~		
aaa	~	~	0.25		

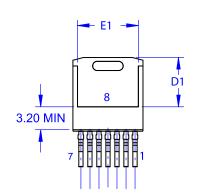




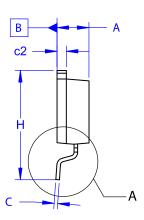
A	<b>—</b> E <b>—</b>	_ L
D		
1		
b2 <b>→</b>		
e	h —	_



LAND PATTERN RECOMMENDATION



⊕ | aaa | B | A | M |



## **GENERIC MARKING DIAGRAM\***



XXXX = Specific Device Code = Assembly Location

= Year WW = Work Week = Pb-Free Package

\*This information is generic. Please refer to

device data sheet for actual part marking.
Pb-Free indicator, "G" or microdot "■", may
or may not be present. Some products may
not follow the Generic Marking.
· ·

DOCUMENT NUMBER:	98AON84234G	Electronic versions are uncontrolled except when accessed directly from the Document Repr Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	D <sup>2</sup> PAK7 (TO-263-7L HV)		PAGE 1 OF 1	

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer pu

#### **PUBLICATION ORDERING INFORMATION**

LITERATURE FULFILLMENT:
Email Requests to: orderlit@onsemi.com

onsemi Website: www.onsemi.com

TECHNICAL SUPPORT North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below:

614233C 648584F IRFD120 JANTX2N5237 2N7000 FCA20N60\_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D MIC4420CM-TR
VN1206L 614234A 715780A SSM6J414TU,LF(T 751625C IPS70R2K0CEAKMA1 2SK2614(TE16L1,Q) DMN1017UCP3-7

EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE2384 NTE2969 NTE6400A

IPS60R3K4CEAKMA1 DMN1006UCA6-7 DMN16M9UCA6-7 STF5N65M6 STU5N65M6 C3M0021120D DMN13M9UCA6-7

BSS340NWH6327XTSA1 IPS60R1K0PFD7SAKMA1 IPS60R360PFD7SAKMA1 IPS60R600PFD7SAKMA1 IPS60R210PFD7SAKMA1

DMN2990UFB-7B IPS60R280PFD7SAKMA1 IPD60R280PFD7SAUMA1 IPD60R360PFD7SAUMA1 SSM3K35CT,L3F

IPLK60R1K0PFD7ATMA1 NTPF450N80S3Z IPLK60R1K5PFD7ATMA1 IPBE65R190CFD7AATMA1 IPB65R190CFD7AATMA1

2N7002W-G